

## Storage A+ Server ASG-1115S-NE316R

1U front-loading all-flash storage server with 16 E3.S NVMe drives and PCIe 5.0



## **Key Applications**

Software-defined Storage, In-Memory Computing, Data Intensive HPC, Private & Hybrid Cloud, NVMe Over Fabrics Solution,

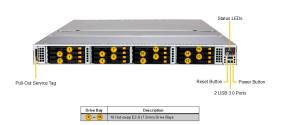
## **Key Features**

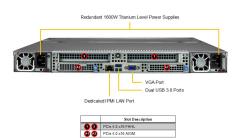
- Single Socket SP5 AMD EPYC™ 9004/9005 Series processor; up to 300W TDP;
- Supports 24 DIMMs with 2DPC, up to 9TB memory capacity with 24 DIMMs of 384GB 3DS RDIMM/RDIMM DDR5 ECC memory;
- 2 PCIe 5.0 x16 slots & 2 AIOM connectors (OCP 3.0 SFF compliant);
- 16 Hot-swap E3.S (7.5mm) NVMe drive bays;
- Redundant Titanium 1600W Power Supplies;



Form Factor	1U Rackmount Enclosure: 438.4 x 43.6 x 773.25mm (17.2" x 1.7" x 30.4") Package: 604.774 x 199.898 x 1029.97mm (23.81" x 7.87" x 40.55")
Processor	Single processor(s)
	AMD EPYC™ 9004/9005 Series Processors
	(* AMD EPYC <sup>™</sup> 9005 Series drop-in support requires board revision 2.x) Up to 96C/192T
System Memory	Slot Count: 24 DIMM slots
	Max Memory (1DPC): Up to 3TB 4800MT/s ECC DDR5 RDIMM (AMD EPYC™ 9004 Series Processor)
	Max Memory (2DPC): Up to 6TB 4000MT/s ECC DDR5 RDIMM (AMD EPYC™ 9004 Series Processor)
	Max Memory (1DPC): Up to 4.5TB 5200MT/s ECC DDR5 RDIMM (AMD EPYC™ 9005 Series Processor)
	Max Memory (2DPC): Up to 9TB 4400MT/s ECC DDR5 RDIMM (AMD EPYC™ 9005 Series Processor)
Drive Bays Configuration	Default: Total 16 bays
	• 16 front hot-swap E3.S 1T PCIe 5.0 x4 NVMe drive bays
	M.2: 1 M.2 PCIe 3.0 x2 NVMe slot (M-key 2280/22110)
	1 M.2 PCIe 3.0 x4 NVMe slot (M-key 2280/22110)
Expansion Slots	PCI-Express (PCIe) Configuration: Default
	• 2 PCIe 5.0 x16 FHHL slots
	<ul> <li>2 PCIe 5.0 x16 AIOM slots (OCP 3.0 compatible)</li> </ul>
	M.2: 2 M.2 PCIe 3.0 x2 NVMe slots (M-key 2280/22110)
On-Board Devices	Chipset: AMD System on Chip
	Network Connectivity: Via AIOM
Input / Output	LAN: 1 RJ45 1 GbE Dedicated BMC LAN port
	USB: 2 USB 3.0 ports(rear)
	2 USB 3.0 ports(front)
	Video: 1 VGA port

(Front View - System)





(Rear View - System)

System Cooling	Fans: 8 Heavy Duty 4cm Fan(s)
Power Supply	1x 1600W Redundant Titanium Level (96%) power supply
System BIOS	BIOS Type: AMI 32MB SPI Flash EEPROM
Management	SuperCloud Composer; Supermicro Server Manager (SSM); Supermicro Update Manager (SUM); Supermicro SuperDoctor® 5 (SD5); Super Diagnostics Offline (SDO); Supermicro Thin-Agent Service (TAS); SuperServer Automation Assistant (SAA) New!
PC Health Monitoring	CPU: Monitors for CPU Cores, Chipset Voltages, Memory 4+1 Phase-switching voltage regulator  FAN: Fans with tachometer monitoring Status monitor for speed control Pulse Width Modulated (PWM) fan connectors  Temperature: Monitoring for CPU and chassis environment Thermal Control for fan connectors  Voltage: +1.8V, +12V, +3.3V, +5V, +5V standby, 10 -fan status, 3.3V standby, HT, Memory, VBAT
Dimensions and Weight	Weight: Gross Weight: 68.74 lbs (31.2 kg)  Net Weight: 48 lbs (21.8 kg)  Available Color: Silver
Operating Environment	RoHS Compliant Operating Temperature: 10°C ~ 35°C (50°F ~ 95°F) Non-operating Temperature: -40°C to 60°C (-40°F to 140°F) Operating Relative Humidity: 8% to 90% (Non-condensing) Non-operating Relative Humidity: 8% to 95% (Non-condensing)
Motherboard	Super H13SSF
Chassis	CSE-126E32-R1K62P